### STP4N90K5



## N-channel 900 V, 1.90 Ω typ.,3 A MDmesh™ K5 Power MOSFET in a TO-220 package

Datasheet - production data

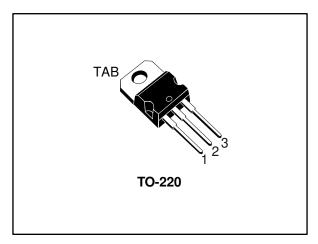
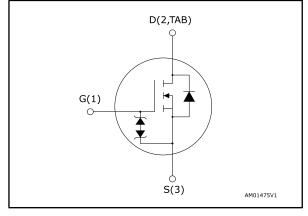


Figure 1: Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ΙD
STP4N90K5	900 V	2.10 Ω	3 A

- Industry's lowest R<sub>DS(on)</sub> x area
- Industry's best FoM (figure of merit)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STP4N90K5	4N90K5	TO-220	Tube

Contents STP4N90K5

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STP4N90K5 Electrical ratings

## 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>G</sub> s	Gate-source voltage	± 30	V
$I_{D}$	Drain current (continuous) at T <sub>C</sub> = 25 °C	3	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	1.9	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (pulsed)	12	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	60	W
dv/dt (2)	Peak diode recovery voltage slope	4.5	1//
dv/dt (3)	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	EE to 150	°C
$T_{stg}$	Storage temperature range	- 55 to 150	30

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	2.08	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	1	Α
Eas	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	160	mJ

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>I_{SD} \leq 3$  A, di/dt  $\leq$  100 A/µs; VDS peak < V(BR)DSS, VDD = 450 V.

 $<sup>^{(3)}</sup>V_{DS} \le 720 \ V$ 

Electrical characteristics STP4N90K5

### 2 Electrical characteristics

T<sub>C</sub> = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	900			٧
		$V_{GS} = 0 \text{ V}, V_{DS} = 900 \text{ V}$			1	μΑ
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 900 \text{ V}$ $T_{C} = 125  {}^{\circ}\text{C}^{(1)}$			50	μΑ
I <sub>GSS</sub>	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DD} = V_{GS}$ , $I_D = 100 \mu A$	3	4	5	٧
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 1.5 \text{ A}$		1.90	2.10	Ω

#### Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		1	173	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	-	17.9	-	pF
Crss	Reverse transfer capacitance	Vu3 – V V	-	1	-	pF
Co(tr) <sup>(1)</sup>	Equivalent capacitance time related	V <sub>DS</sub> = 0 to 720 V,	-	29	-	рF
C <sub>o(er)</sub> (2)	Equivalent capacitance energy related	V <sub>GS</sub> = 0 V	1	11	-	рF
Rg	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	ı	15.5	-	Ω
Qg	Total gate charge	V <sub>DD</sub> = 720 V, I <sub>D</sub> = 3 A	-	5.3	-	nC
$Q_{gs}$	Gate-source charge	V <sub>GS</sub> = 10 V	-	1.45	-	nC
$Q_{gd}$	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	2.8	-	nC

#### Notes:

 $<sup>^{\</sup>left(1\right)}$  Defined by design, not subject to production test.

 $<sup>^{(1)}</sup>$  Time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{\text{oss}}$  when  $V_{\text{DS}}$  increases from 0 to 80%  $V_{\text{DSS}}$ .

 $<sup>^{(2)}</sup>$  Energy related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

Table 7: Switching times

Table 11 Contenting times						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD}=450 \text{ V}, I_D=1.50 \text{ A},$	1	10.5	1	ns
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$	1	11.8	1	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times"	ı	26.4	1	ns
tf	Fall time	and Figure 19: "Switching time waveform")	-	25.5	-	ns

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		3	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		12	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 3 A, V <sub>GS</sub> = 0 V	-		1.5	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 3 \text{ A, di/dt} = 100 \text{ A/}\mu\text{s,V}_{DD} =$	-	289		ns
Qrr	Reverrse recovery charge	60 V (see Figure 16: "Test circuit for	-	1.56		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	10.8		Α
t <sub>rr</sub>	Reverse recovery time	I <sub>SD</sub> = 3 A, di/dt = 100 A/μs V <sub>DD</sub> =	-	494		ns
Qrr	Reverse recovery charge	60 V, T <sub>j</sub> = 150 °C (see <i>Figure 16: "Test circuit for</i>	-	2.45		μС
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")	-	9.9		Α

#### Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)GSO</sub>	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_D = 0 \text{ A}$	30	-	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



<sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>$ Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

### 2.1 Electrical characteristics (curves)

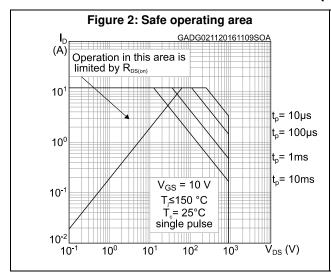
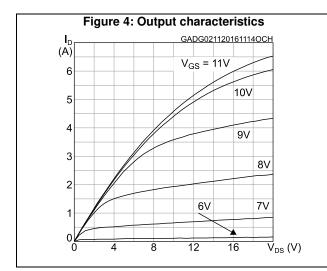
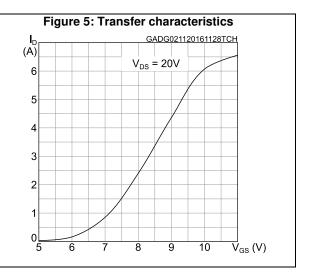
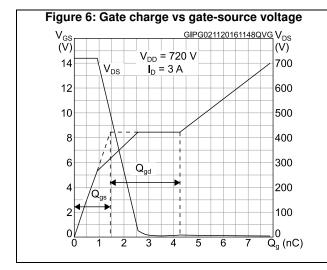
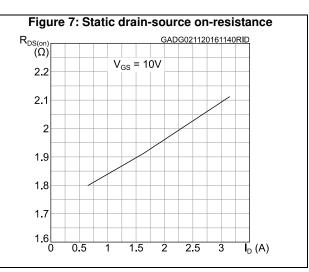


Figure 3: Thermal impedance  $K \\ \hline \delta = 0.5 \\ \hline \delta = 0.1 \\ \hline \delta = 0.1 \\ \hline \Delta_{th} = k R_{thj-C} \\ \hline \delta = t_p / T \\ \hline \Delta_{th} = k R_{thj-C} \\ \hline \Delta_{thj-C} = k$ 





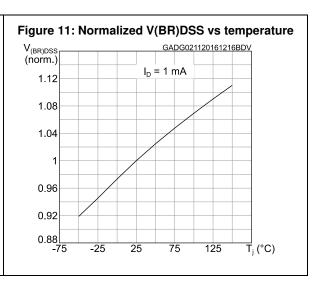


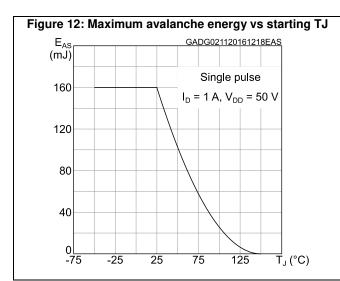


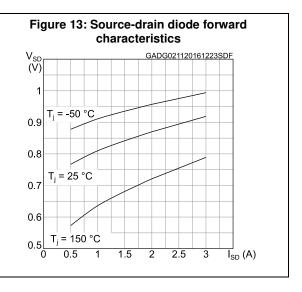
STP4N90K5 Electrical characteristics

Figure 8: Capacitance variations C (pF) GADG021120161147CVR f = 1MHz1000 C<sub>ISS</sub> 100 10  $C_{oss}$  $C_{RSS}$ V<sub>DS</sub> (V) 10<sup>-1</sup> 10<sup>0</sup> 10<sup>1</sup>  $10^{2}$ 

Figure 10: Normalized on-resistance vs temperature  $R_{DS(on)}$  (norm.)  $Q_{GADG021120161213RON}$   $Q_{GADG021120161213RON$ 







**Test circuits** STP4N90K5

#### 3 **Test circuits**

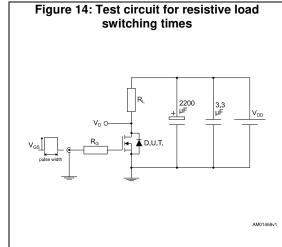


Figure 15: Test circuit for gate charge behavior RL I<sub>G</sub>= CONST 100 Ω  $2.7 \ k\Omega$ 47 kΩ AM01469v10

Figure 16: Test circuit for inductive load switching and diode recovery times

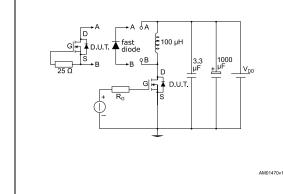


Figure 17: Unclamped inductive load test circuit

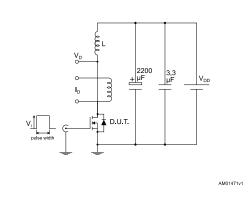


Figure 18: Unclamped inductive waveform

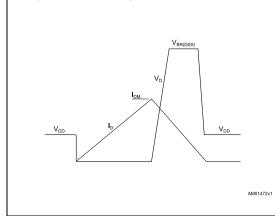
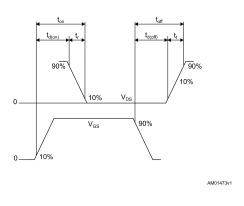


Figure 19: Switching time waveform



STP4N90K5 Package information

### 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

# 4.1 TO-220 package information

Figure 20: TO-220 type A package outline

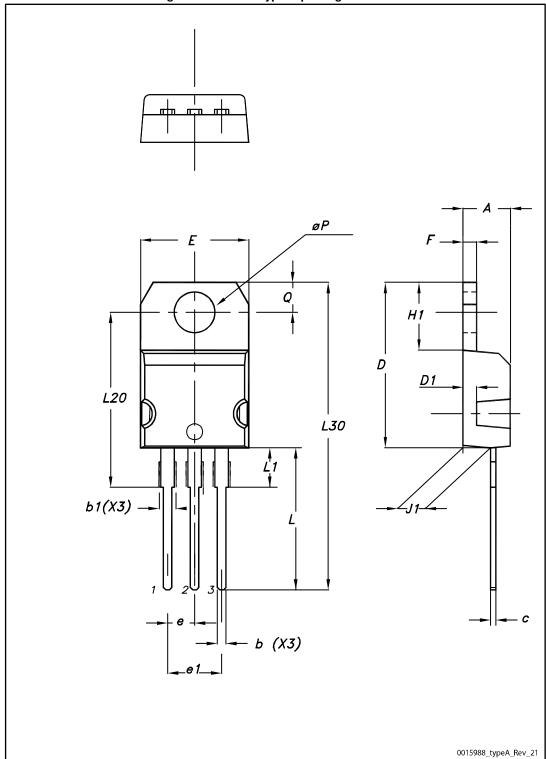


Table 10: TO-220 type A mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øΡ	3.75		3.85
Q	2.65		2.95

Revision history STP4N90K5

## 5 Revision history

**Table 11: Document revision history** 

Date	Revision	Changes
02-Nov-2016	1	First release.

#### **IMPORTANT NOTICE - PLEASE READ CAREFULLY**

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